# IN 1 INTERNAL 2 IC VR SUB 6 GND SUPPLY 3 Vs 6 GND ENABLE 4 Dwg. PK-012

### **ABSOLUTE MAXIMUM RATINGS**

Input Voltage, V <sub>I</sub> 16 V
Supply Voltage, V <sub>S</sub> 16 V
Continuous Output Current, $I_O$ 1.0 $A^*$
Logic Input Voltage, $V_E$ $V_S$
Package Power Dissipation, P <sub>D</sub> <b>See Graph</b>
Output Junction Temperature, T <sub>J</sub> <b>+150</b> °C†
Operating Temperature Range, T <sub>A</sub> 30°C to +100°C
Storage Temperature Range, T <sub>stg</sub> 30°C to +150°C

- \* Output current rating may be limited by duty cycle, ambient temperature, and heat sinking. Under any set of conditions, do not exceed the specified current rating or a junction temperature of 150°C.
- † Fault conditions that produce excessive junction temperature will activate the device's thermal shutdown circuitry. These conditions can be tolerated but should be avoided.

### LOW-VOLTAGE, HIGH-CURRENT 2.5 V LINEAR REGULATOR

The SI-3025LSA is designed to meet the requirement for increased integration and reliability in low-voltage, high-current, linear regulator applications such as personal computers (PCs) and set-top boxes. Each device incorporates a monolithic low-level reference and control circuit with a high-current pnp transistor in a power multi-chip module (PMCM<sup>TM</sup>). Regulated output voltages of 1.8 V or 3.3 V are also available.

The high-current pass element provides a low dropout voltage with output current to 1 A. Regulator accuracy of  $\pm 2$  % and excellent temperature characteristics are provided. The logic-compatible ENABLE input gives the designer complete control over power up, power down, and standby or sleep.

These devices are supplied in a fully molded 8-lead miniature surface-mount package (tape and reel) with enhanced power-dissipating qualities. They are rated for continuous operation between -30 $^{\circ}$ C and +100 $^{\circ}$ C.

### **FEATURES**

- 1 A Output Current
- Low Dropout voltage
- LSTTL/CMOS-Compatible On/Off Control Less Than 1 μA "Sleep" Current
- Internal Foldback Overcurrent Limiting
- Internal Thermal Shutdown
- Surface-Mount Package

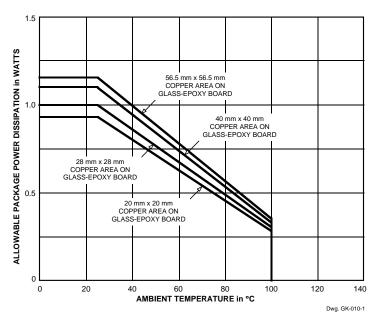
Always order by complete part number: SI-3025LSA-TL where "-TL" indicates tape and reel.





# INPUT INTERNAL 2 SUPPLY 3 ENABLE 4 GROUND 5 FUNCTIONAL BLOCK DIAGRAM (8) OUTPUT (8) OUTPUT (6) GROUND

Dwg. FK-019



Leads 7 and 8 are soldered to the copper area and provide heat sinking of the pass transistor

### RECOMMENDED OPERATING CONDITIONS

Max. Input Voltage, V <sub>I</sub>	5 V
Output Current, I <sub>O</sub> <b>0 A to 1.0</b>	) A
Output Junction Temperature Range, T $_{ extsf{J}}$ <b>-20</b> $^{\circ}$ C to <b>+125</b>	;°C
Ambient Temperature Range, T <sub>A</sub> 30°C to +85	°C





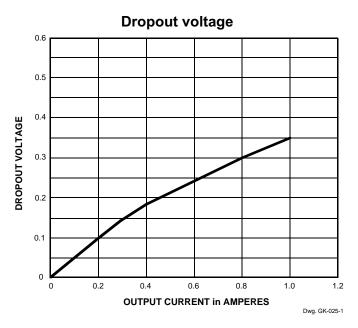
# **ELECTRICAL CHARACTERISTICS** at $T_A = +25^{\circ}C$ , $V_I = V_S = 3.3 \text{ V}$ , $V_E = 2.0 \text{ V}$ (unless otherwise noted).

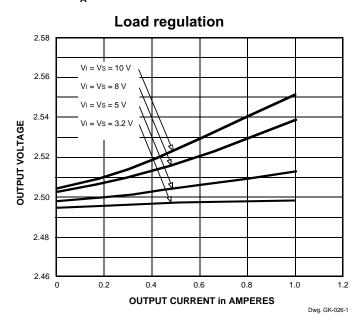
			Limits			
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Output Voltage	V <sub>o</sub>	I <sub>O</sub> = 500 mA	2.45	2.50	2.55	٧
V <sub>oq</sub>		V <sub>E</sub> = 0 V, Output Off	_	_	0.5	V
Output Volt. Temp. Coeff.	a <sub>VO</sub>	$I_{O} = 5 \text{ mA}, \ 0^{\circ}\text{C} \le T_{J} \le 100^{\circ}\text{C}$		±0.3	_	mV/°C
Overcurrent Limit	I <sub>OM</sub>	$V_{\rm O}$ = 95% of $V_{\rm O}$ at $I_{\rm O}$ = 500 mA	1.2	1.5	_	Α
Line Regulation $\Delta V_{O(\Delta VI)}$		$3.1 \text{ V} \le \text{V}_{\text{I}} = \text{V}_{\text{S}} \le 3.5 \text{ V}, \text{ I}_{\text{O}} = 300 \text{ mA}$	_	2.0	10	mV
Load Regulation	$\Delta V_{O(\Delta IO)}$	0 ≤ I <sub>0</sub> ≤ 1 A		10	20	mV
Dropout Voltage	V <sub>I</sub> min - V <sub>O</sub>	I <sub>o</sub> ≤ 0.5 A	_	220	400	mV
		I <sub>o</sub> ≤1 A		350	800	mV
Ground Terminal Current	I <sub>GND</sub>	I <sub>o</sub> = 0 mA		1.7	2.5	mA
	I <sub>Q</sub>	V <sub>E</sub> = 0 V, I <sub>O</sub> = 0 mA		_	1.0	μΑ
Rejection Ratio	PSRR	100 Hz ≤ f ≤ 120 Hz		57	_	dB
ENABLE Input Voltage	$V_{EH}$	Output On	2.0	_	_	V
	V <sub>EL</sub>	Output Off		_	0.8	V
ENABLE Input Current	I <sub>EH</sub>	V <sub>E</sub> = 2 V, Output On	_	40	80	μΑ
	I <sub>EL</sub>	V <sub>E</sub> = 0 V, Output Off	_	0	-5.0	μΑ
Thermal Shutdown Temp.	$T_J$		135	150	_	°C
Thermal Resistance	$R_{\scriptscriptstyle{ hetaJL}}$	To terminals 7 and 8	_	36	_	°C/W

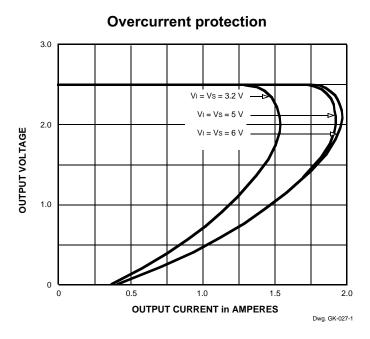
Typical values are at  $T_A$  = +25°C and are given for circuit design information only.

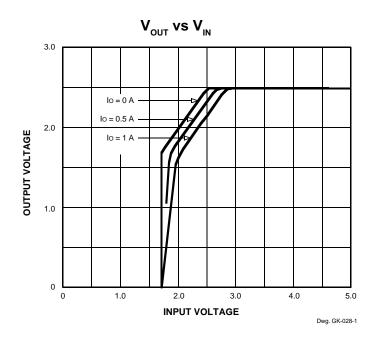
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### TYPICAL CHARACTERISTICS at $T_A = 25^{\circ}C$





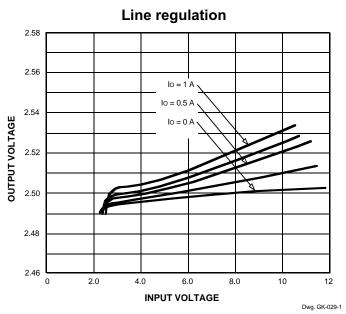


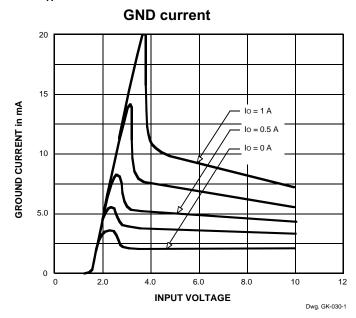


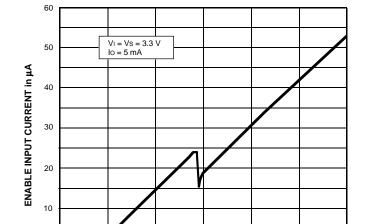




### TYPICAL CHARACTERISTICS at $T_A = 25^{\circ}C$ (cont'd)







0.5

**ENABLE** input current

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**ENABLE VOLTAGE in VOLTS** 

2.5

Dwg. GK-023

### APPLICATIONS INFORMATION

**Thermal shutdown and heat sinking.** Thermal protection circuitry turns off the device should the junction temperature rise above 135°C. This is intended only to protect the device from failures due to excessive junction temperatures and should not imply that high-temperature operation is permitted. Ambient temperature is affected by air circulation and proximity to other heat-producing components. Normal operation is resumed when the junction temperature is reduced. Output terminals 7 and 8 are the lead frame and substrate of the pass transistor and provide a low thermal-resistance path for heat sinking.

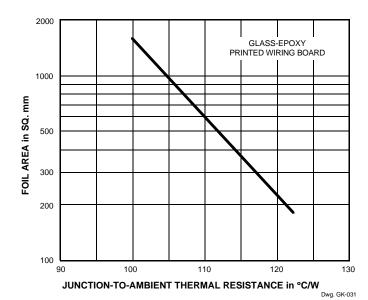
In general, the maximum ambient temperature has the most effect on determining the heat sinking that is needed to maintain a safe normal operating junction temperature. The maximum heat sinking thermal resistance  $(R_{_{\rm BIA}})$  can be calculated as

$$R_{\theta JA} = (135 - T_A) / I_O (V_I - 2.5)$$

where  $T_A$  is the maximum ambient temperature in °C,  $I_O$  is the maximum output (load) current in amperes, and  $V_I$  is the maximum input voltage in volts.

The following graph gives the required copper foil area (soldered to leads 7 and 8) to provide the required thermal resistance. Note that more is always better and both sides of the printed wiring board can be used.

**ENABLE input.** The ENABLE input includes an internal pull-



down resistor. If this terminal is not connected (open-circuit fault), the device output is turned off.

**Overcurrent protection.** The SI-3025LSA includes an overcurrent protection circuit, which limits the output current at start up. It thus cannot be used with

- 1) a constant-current load,
- 2) a power supply with positive and negative to a common load (center-tap type power supply),
- 3) a series power supply, or
- 4) a diode or resistor in series with the device ground to raise the output voltage.

**Input voltage.** Including ripple voltage and transients, the minimum input voltage should be greater than the sum of the output voltage and the maximum rated dropout voltage; the maximum input voltage must be less than the absolute maximum rated input voltage (16 V).

In most applications, the input voltage (terminal 1,  $V_1$ ) and the supply voltage (terminal 3,  $V_s$ ) are connected together.

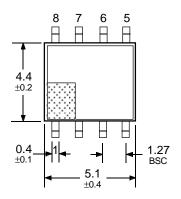
**Output capacitor.** A 22  $\mu$ F tantalum electrolytic capacitor is recommended between the output and ground. Very-low ESR capacitors should not be used.

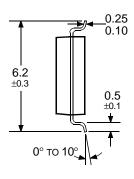
**Input capacitor.** A  $0.1~\mu F$  to  $10~\mu F$  tantalum capacitor is recommended between the input and ground to prevent oscillation.

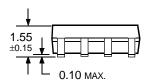




# Dimensions in Millimeters (controlling dimensions)







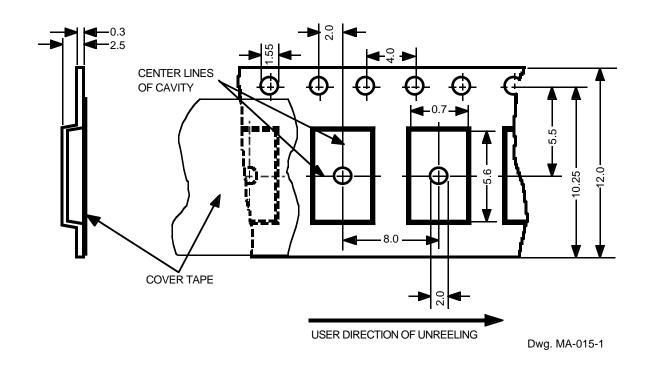
Dwg. MK-006-8 mm

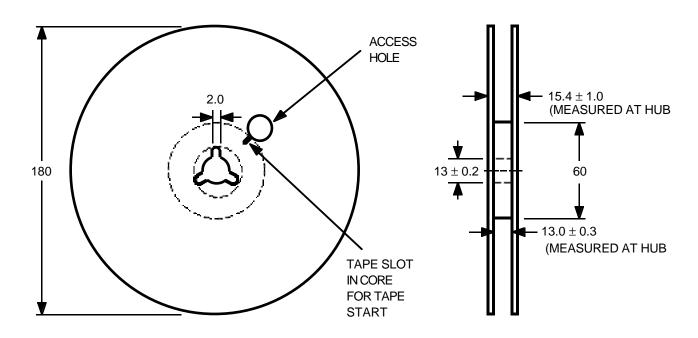
NOTES: 1. Exact body and lead configuration at vendor's option within limits shown.

- 2. Lead spacing tolerance is non-cumulative.
- 3. Leads 7 and 8 are internally connected together and provide heat sinking of the pass transistor.

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## Tape and Reel Dimensions in Millimeters (controlling dimensions)





Dwg. MA-018-1





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### LINEAR REGULATORS

### IN ORDER OF 1) OUTPUT VOLTAGE AND 2) OUTPUT CURRENT

				Part	
Vo	Max I <sub>O</sub>	Max DC In	Max. Dropout Voltage	Number	Package
1.8 V	1.0 A	16 V	1.2 V @ 1.0 A	SI-3018LSA	8-Lead SOIC
2.5 V	1.0 A	16 V	800 mV @ 1.0 A	SI-3025LSA	8-Lead SOIC
3.3 V	1.0 A	16 V	800 mV @ 1.0 A	SI-3033LSA	8-Lead SOIC
3.3 V	1.5 A	20 V	500 mV @ 1.0 A	SI-3033C	5-Lead TO-220
5.0 V	1.0 A	25 V	500 mV @ 0.5 A	SI-3050N	TO-220
5.0 V *	1.5 A	35 V	1.0 V @ 1.5 A	SLA3001M	Power-Tab SIP
5.0 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3050C	5-Lead TO-220
5.0 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3051N	TO-220
5.0 V	2.0 A	25 V	500 mV @ 1.0 A	SI-3052V	TO-3P
7.7 V	15 mA	30 V	_	A8178LLT	SOT-89
9.0 V	1.0 A	30 V	500 mV @ 0.5 A	SI-3090N	TO-220
9.0 V *	1.5 A	35 V	1.0 V @ 1.5 A	SLA3001M	Power-Tab SIF
9.0 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3090C	5-Lead TO-220
9.0 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3091N	TO-220
12 V	1.0 A	30 V	500 mV @ 0.5 A	SI-3120N	TO-220
12 V *	1.5 A	35 V	1.0 V @ 1.5 A	SLA3001M	Power-Tab SIF
12 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3120C	5-Lead TO-220
12 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3121N	TO-220
12 V	2.0 A	30 V	500 mV @ 1.0 A	SI-3122V	TO-3P
15 V	1.0 A	35 V	500 mV @ 0.5 A	SI-3150N	TO-220
15 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3150C	5-Lead TO-220
15 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3151N	TO-220
15 V	2.0 A	30 V	500 mV @ 1.0 A	SI-3152V	TO-3P
15.7 V †	1.0 A	35 V	1.0 V @ 1.0 A	SLA3002M	Power-Tab SIP
24 V	1.5 A	45 V	500 mV @ 1.0 A	SI-3240C	5-Lead TO-220
24 V	1.5 A	45 V	500 mV @ 1.0 A	SI-3241N	TO-220

<sup>\*</sup> Three outputs, one each at 5 V, 9 V, and 12 V.

Also, see 83145 and 84145 Latched, Universal Input-Voltage Switches.





 $<sup>\</sup>dagger$  Also includes two switching regulator outputs for 5 V at 500 mA and 9 V at 400 mA.